

Oxygen Free Copper

Oxygen free copper contains extremely low oxygen (<0.001%). Its fine grain structure performs better anode consumption and minimal amount of anode sludge, thus reducing coating bath cleaning frequency and saving costs.



Production process

Melting => MPCA Tech => Cold Heading => Polish & Clean => Packing

Elements Content						
Cu + Ag (%)	Fe (%)	Pb (%)	Ni (%)	Zn (%)	Sb (%)	Sn (%)
≥99.95	≤0.003	≤0.003	≤0.003	≤0.003	≤0.003	≤0.003

Product	Appearance	Packaging
Oxygen Free Ball	ø11mm, ø25mm, ø28mm	Pail: 50 Kg/Pail
Oxygen Free Copper	ø8mm * 15mm, ø16mm * 30mm	Box : 25 Kg/Box